PD - 94956

International **TOR** Rectifier

IRFZ48PbF

 $V_{DSS} = 60V$

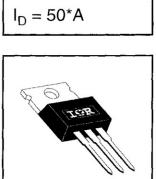
HEXFET[®] Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Ultra-Low On-Resistance
- Very Low Thermal Resistance
- 175°C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Lead-Free

Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 waits. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



TO-220AB

 $R_{DS(on)} = 0.018\Omega$

Absolute Maximum Ratings

	Parameter	Max.	Units	
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10 V 50*			
I _D @ T _C = 100°C	Continuous Drain Current, VGS @ 10 V	50*	A	
DM	Pulsed Drain Current ①	290		
P _D @ T _C = 25°C	Power Dissipation	190	W	
	Linear Derating Factor	1.3	W/°C	
V _{GS}	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy 2	100	mJ	
lar	Avalanche Current ①	50	A	
EAR	Repetitive Avalanche Energy ①	19	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	4.5	V/ns	
TJ	Operating Junction and	-55 to +175		
TSTG	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)		

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
Rejc	Junction-to-Case			0.80	
Recs	Case-to-Sink, Flat, Greased Surface		0.50	_	°C/W
Reja	Junction-to-Ambient	_	_	62	1

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	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	60			V	$V_{GS}=0V, I_D=250\mu A$	
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	-	0.060	_	V/°C	Reference to 25°C, ID= 1mA	
R _{DS(on)}	Static Drain-to-Source On-Resistance		-	0.018	Ω	V _{GS} =10V, I _D =43A ④	
V _{GS(th)}	Gate Threshold Voltage	2.0	_	4.0	V	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	
g ts	Forward Transconductance	27	_		S	V _{DS} =25V, I _D =43A ④	
	Ducin to Course Lookage Coursent	_		25		V _{DS} =60V, V _{GS} =0V	
DSS	Drain-to-Source Leakage Current		-	250	μA	V _{DS} =48V, V _{GS} =0V, T _J =150°C	
	Gate-to-Source Forward Leakage	-	-	100	nA	V _{GS} =20V	
IGSS	Gate-to-Source Reverse Leakage	_	-	-100	nA	V _{GS} =-20V	
Qg	Total Gate Charge	_	_	110		I _D =72A	
Q _{gs}	Gate-to-Source Charge		-	29	nC	V _{DS} =48V	
Q _{gd}	Gate-to-Drain ("Miller") Charge	_	_	36		V _{GS} =10V See Fig. 6 and 13 ④	
t _{d(on)}	Turn-On Delay Time	—	8.1	—		V _{DD} =30V	
tr	Rise Time	—	250		ns	1 _D =72A	
t _{d(off)}	Turn-Off Delay Time	_	210		113	R _G =9.1Ω	
t,	Fall Time	- 1	250	-		R _D =0.34Ω See Figure 10 @	
LD	Internal Drain Inductance		4.5	-	nH	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance	_	7.5			from package and center of die contact	
Ciss	Input Capacitance		2400	-		V _{GS} =0V	
Coss	Output Capacitance	—	1300	-	pF	V _{DS} =25V	
Crss	Reverse Transfer Capacitance		190	-		f=1.0MHz See Figure 5	

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

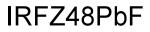
	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Is	Continuous Source Current (Body Diode)	—	·	50*	A	MOSFET symbol showing the
ISM	Pulsed Source Current (Body Diode) ①	_	-	290		integral reverse p-n junction diode.
VSD	Diode Forward Voltage	—	-	2.0	V	T_=25°C, Is=72A, VGS=0V @
trr	Reverse Recovery Time	-	120	180	ns	TJ=25°C, I⊧=72A
Qrr	Reverse Recovery Charge	—	0.50	0.80	μC	di/dt=100A/μs ④
ton	Forward Turn-On Time	Intrinsi	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)			

Notes:

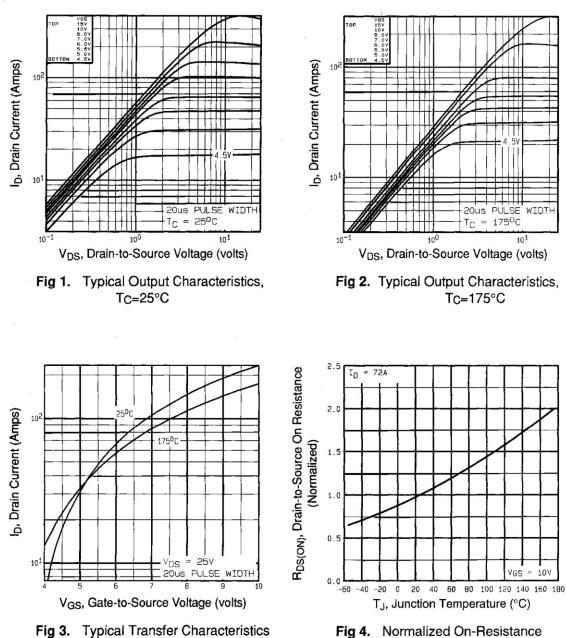
① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)

- ② V_{DD}=25V, starting T_J=25°C, L=22µH R_G=25Ω, I_{AS}=72A (See Figure 12)
- (Pulse width \leq 300 µs; duty cycle \leq 2%.
- * Current limited by the package, (Die Current =72A)

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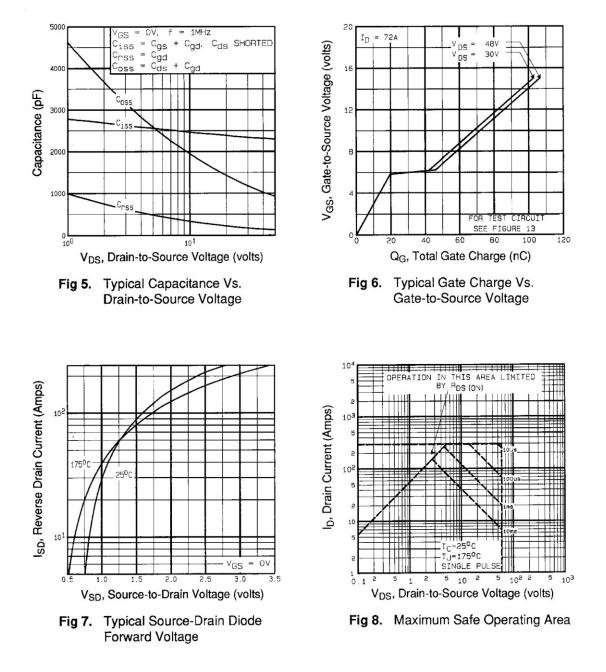


Vs. Temperature

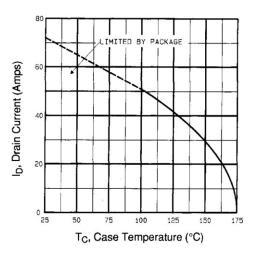
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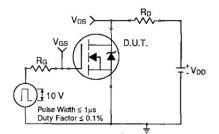
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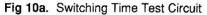


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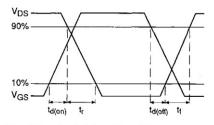


Fig 10b. Switching Time Waveforms

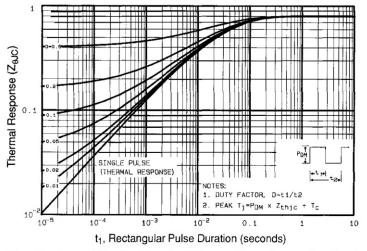
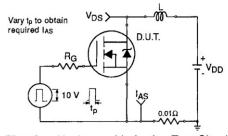
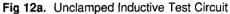


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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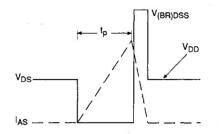


Fig 12b. Unclamped Inductive Waveforms

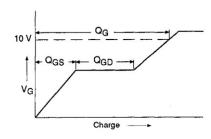


Fig 13a. Basic Gate Charge Waveform

Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit – See page 1505 Appendix B: Package Outline Mechanical Drawing – See page 1509

Appendix E: Optional Leadforms - See page 1525

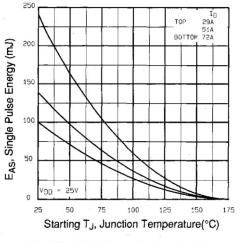


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

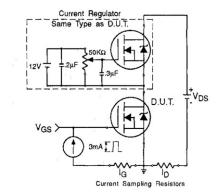


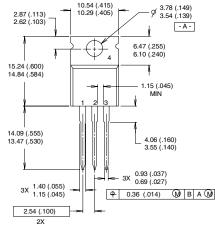
Fig 13b. Gate Charge Test Circuit

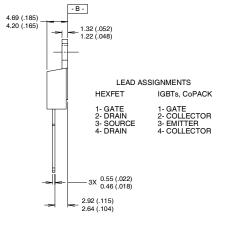
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TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



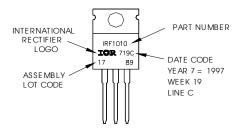


NOTES:

1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982. 2 CONTROLLING DIMENSION : INCH 3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB. 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010 LOT CODE 1789 ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C" **Note:** "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

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